

## PA3202

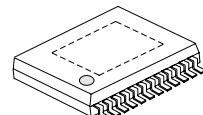
CMOS IC

## 2-W STEREO AUDIO POWER AMPLIFIER WITH MUTE

## ■ DESCRIPTION

The UTC **PA3202** is a monolithic integrated circuit that stereo bridged audio power amplifiers capable of producing 2 W into 3Ω with a 5V supply voltage or 800mW into 3Ω with a 3.3V supply voltage .The UTC **PA3202** simplifies design and frees up board space for other features. Both of the depop circuitry and the thermal shutdown protection circuitry are integrated in UTC **PA3202**, that reduce clicks and pops noise during power up or shutdown mode operation.

A MUX control terminal (HP/LINE) allows selection between the two sets of stereo input signals. To simplify the audio system design, UTC **PA3202** combines a stereo bridge-tied loads (BTL)mode for speaker drive and a stereo single-end (SE)mode for headphone drive into a single chip, where both modes are easily switched by the SE/BTL input control pin signal.



HTSSOP-24

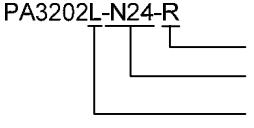
\*Pb-free plating product number: PA3202L

## ■ FEATURES

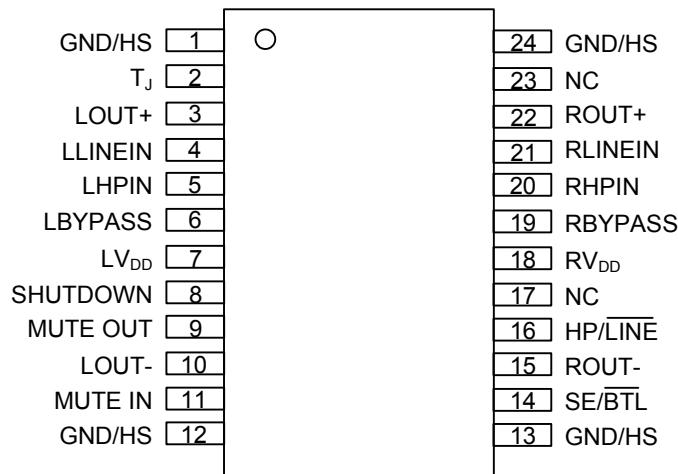
- \* Improves depop circuitry to eliminate turn-on and turn-off transients in output
- \* Output power:  
-2W(typ.)@5V into 3Ω with 0.2% THD+N max (1kHz)  
-800mW(typ.)@3.3V into 3Ω with 0.2% THD+N max (1kHz)
- \* Fully specified for use with 3-Ω Loads
- \* Stereo switchable bridged/single-ended power amplifiers
- \* Input MUX select terminal
- \* Thermal-shutdown protection
- \* Shutdown mode available

## ■ ORDERING INFORMATION

Ordering Number		Package	Packing
Normal	Lead Free Plating		
PA3202-N24-R	PA3202L-N24-R	HTSSOP-24	Tape Reel
PA3202-N24-T	PA3202L-N24-T	HTSSOP-24	Tube

 (1)Packing Type (2)Package Type (3)Lead Plating	(1) R: Tape Reel, T: Tube (2) N24: HTSSOP-24 (3) L: Lead Free Plating, Blank: Pb/Sn
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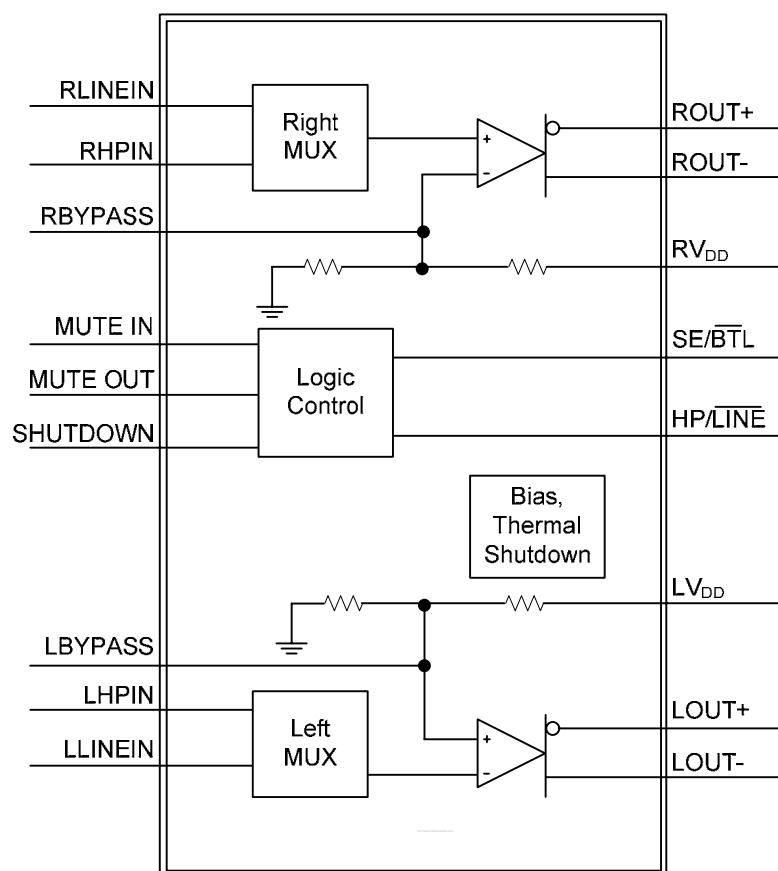
■ PIN CONFIGURATION



■ PIN DESCRIPTION

PIN NO	PIN NAME	I/O	DESCRIPTION
1, 12, 13, 24	GND/HS		Power ground; directly connected to thermal pad.
6	LBYPASS		Tap to left channel internal mid-supply voltage divider bias
17, 23	NC		No connection
19	RBYPASS		Tap to right channel internal mid-supply voltage divider bias
4	LLINE IN	I	Left channel line input; selected when HP/LINE is held low
5	LHP IN	I	Left channel headphone input; selected when HP/LINE is held high
7	LV <sub>DD</sub>	I	Left channel power supply and for primary bias circuits
8	SHUTDOWN	I	Places entire IC in shutdown mode when held high, I <sub>DD</sub> = 5µA
9	MUTE OUT	I	Follows MUTE IN, provides buffered output
11	MUTE IN	I	Mute all amplifiers input; high active to mute amplify, low active to normal operation
14	SE/BTL	I	SE & BTL mode selection; active high for SE mode, active low for BTL mode
16	HP/LINE	I	MUX control input, active high to select headphone input, active low to select line input
18	RV <sub>DD</sub>	I	Right channel power supply
20	RHPIN	I	Right channel headphone input, selected when HP/LINE is held high
21	RLINEIN	I	Right channel line input, selected when HP/LINE is held low
2	T <sub>J</sub>	O	Sources current proportional to the junction temperature. Left floating for normal operation.
3	LOUT+	O	Left channel + output in BTL & SE mode
10	LOUT-	O	Left channel – output in BTL mode & high-impedance in SE mode
22	ROUT+	O	Right channel + output in BTL & SE mode
15	ROUT-	O	Right channel – output in BTL mode & high impedance in SE mode

## ■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Supply Voltage	V <sub>DD</sub>	6	V
Input Voltage	V <sub>IN</sub>	-0.3~V <sub>DD</sub> ~+0.3	V
Continuous Total Power Dissipation	P <sub>D</sub>	Internally limited	
Junction Temperature	T <sub>J</sub>	+150	
Operating Temperature	T <sub>OPR</sub>	-40 ~ +85	
Storage Temperature	T <sub>STG</sub>	-65 ~ +150	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL		MIN	NOM	MAX	UNIT
Supply Voltage	V <sub>DD</sub>		3	5	5.5	V
Operating Temperature	T <sub>OPR</sub>	V <sub>DD</sub> = 5 V, 250 mW/ch average power, with proper PCB design	-40		85	
		V <sub>DD</sub> = 5 V, 2 W/ch average power, with proper PCB design	-40		85	
Common Mode Input Voltage	V <sub>ICM</sub>	V <sub>DD</sub> =5V V <sub>DD</sub> =3.3V	1.25		4.5	V
			1.25		2.7	

■ DC ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP(1)	MAX	UNIT
Supply Current	I <sub>DD</sub>	V <sub>DD</sub> =5V	Stereo BTL	19	30	mA
			Stereo SE	9	18	
			Mono BTL	9	18	
			Mono SE	3	10	
		V <sub>DD</sub> =3.3V	Stereo BTL	13	20	mA
			Stereo SE	5	10	
			Mono BTL	5	10	
			Mono SE	3	6	
Output Offset Voltage (Measured Differentially)	V <sub>O(OFF)</sub>	V <sub>DD</sub> = 5 V, Gain = 2, See Note 1		5	25	mV
Supply Current in Mute Mode	I <sub>DD(MUTE)</sub>	V <sub>DD</sub> =5V		1		mA
I <sub>DD</sub> in Shutdown	I <sub>DD(SD)</sub>	V <sub>DD</sub> =5V		5	19	μA

Note 1. At 3 V < V<sub>DD</sub> < 5 V the dc output voltage is approximately V<sub>DD</sub><sup>2</sup>.

## ■ AC OPERATING CHARACTERISTICS

**V<sub>DD</sub> = 5 V, T<sub>A</sub> = 25 °C, R<sub>L</sub> = 3Ω**

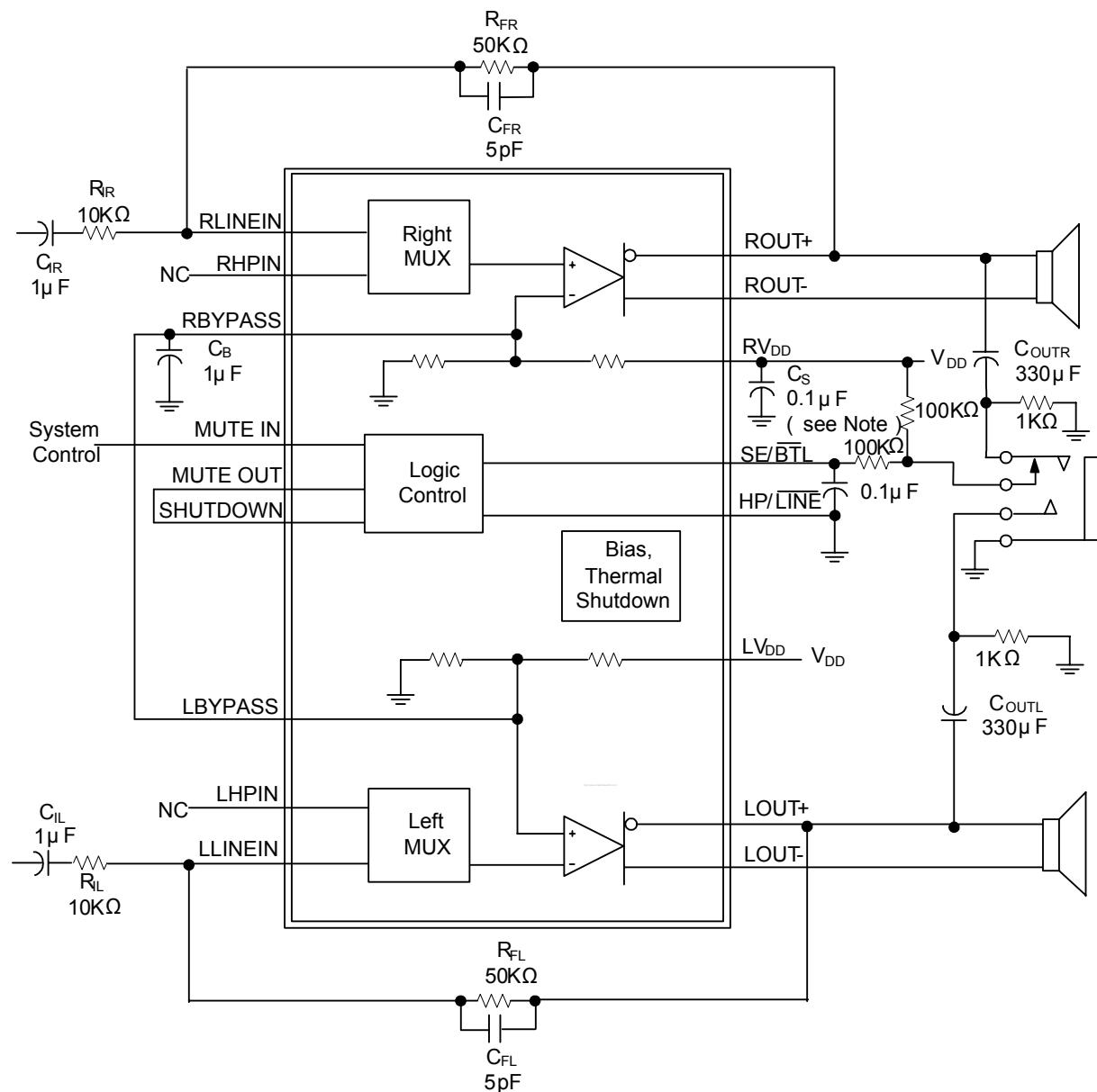
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Output Power (Each Channel) See Note 2	P <sub>OUT</sub>	THD =0.2% BTL		2		W
		THD =1% BTL		2.2		
Total Harmonic Distortion Plus Noise	TDH+N	P <sub>OUT</sub> = 2 W, f = 20 ~ 20 kHz	200			m%
		V <sub>IN</sub> = 1V, R <sub>L</sub> =10KΩ, A <sub>V</sub> =1V/V	100			
Maximum Output Power Bandwidth	B <sub>W</sub>	A <sub>V</sub> = 10 V/V , THD < 1 %,	>20			KHz
Phase Margin		R <sub>L</sub> = 4 Ω, Open Loop,	85°			
Supply Ripple Rejection Ratio	RR	f = 1 kHz		80		dB
		f = 20~20kHz,		60		
Mute Attenuation			85			dB
Channel-to-Channel Output Separation		f = 1 kHz	85			dB
Line/HP Input Separation			100			dB
BTL Attenuation in SE Mode			100			dB
Input Impedance	Z <sub>IN</sub>		2			MΩ
Signal-to-Noise Ratio		P <sub>OUT</sub> =500mW, BTL	95			dB
Output Noise Voltage	eN		21			µV <sub>(RMS)</sub>

**V<sub>DD</sub> = 3.3 V, T<sub>A</sub> = 25 °C, R<sub>L</sub> = 3Ω**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Output Power ( Each Channel) See Note 2	P <sub>OUT</sub>	THD =0.2% BTL		800		mW
		THD =1% BTL		900		
Total Harmonic Distortion Plus Noise	TDH+N	P <sub>OUT</sub> = 800mW, f = 20 ~ 20 kHz	350			m%
		V <sub>IN</sub> = 1V, R <sub>L</sub> =10KΩ, A <sub>V</sub> =1V/V	200			
Maximum Output Power Bandwidth	B <sub>W</sub>	A <sub>V</sub> = 10 V/V, THD < 1 %,	>20			KHz
Phase Margin		R <sub>L</sub> = 4 Ω, Open Loop	85°			
Supply Ripple Rejection Ratio	RR	f = 1 kHz		70		dB
		f = 20~20kHz,		55		
Mute Attenuation			85			dB
Channel-to-Channel Output Separation		f = 1 kHz	85			dB
Line/HP Input Separation			100			dB
BTL Attenuation in SE Mode			100			dB
Input Impedance	Z <sub>IN</sub>		2			MΩ
Signal-to-Noise Ratio		P <sub>OUT</sub> =500mW, BTL	95			dB
Output Noise Voltage	eN		21			µV <sub>(RMS)</sub>

Note 2. Output power is measured at the output terminals of the IC at 1 kHz.

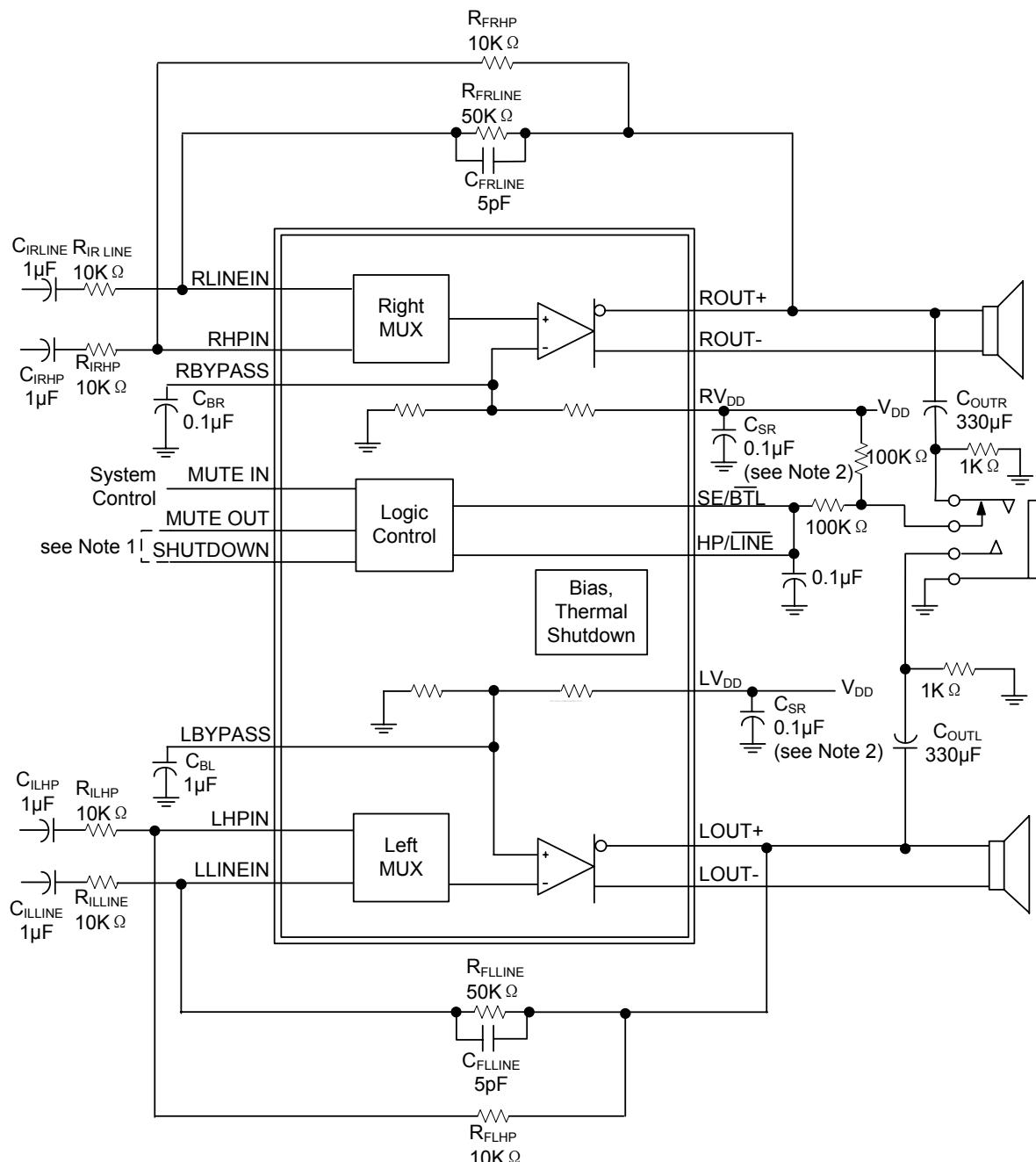
## ■ TYPICAL APPLICATION CIRCUIT



Note: 0.1  $\mu$  F ceramic capacitor should be placed as close as possible to the IC. For filtering lower frequency noise signals, a larger aluminum electrolytic capacitor of 10  $\mu$ F or greater should be placed near the audio power amplifier.

PA3202 Minimum Configuration Application Circuit

■ TYPICAL APPLICATION CIRCUIT

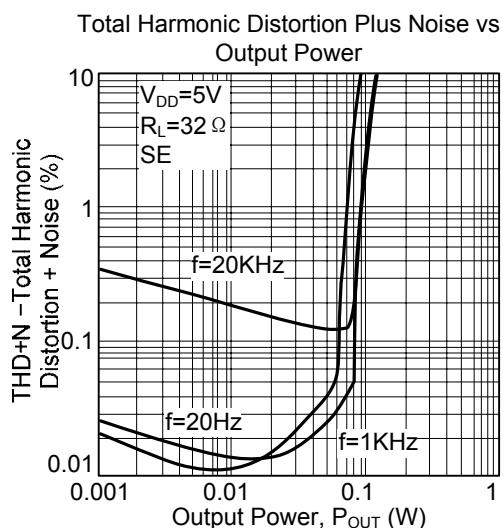
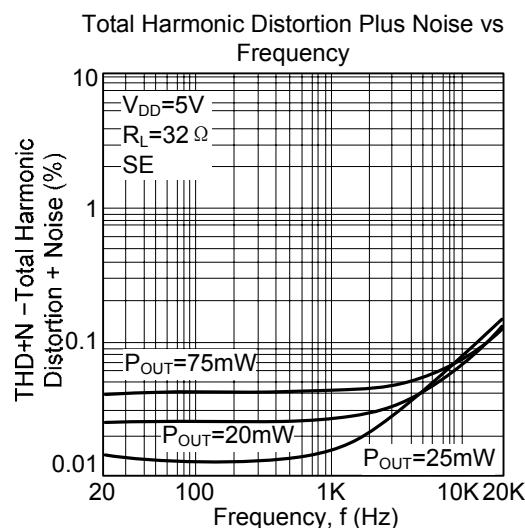
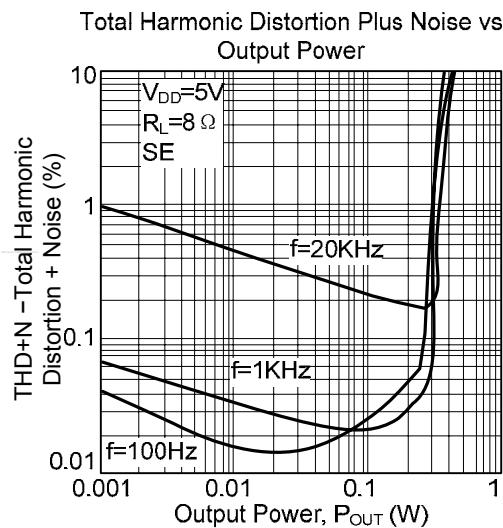
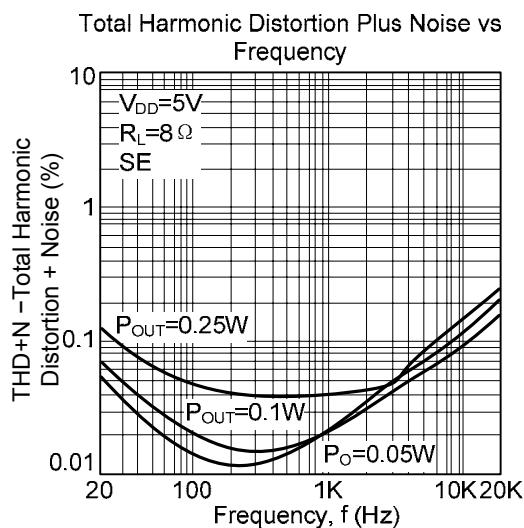
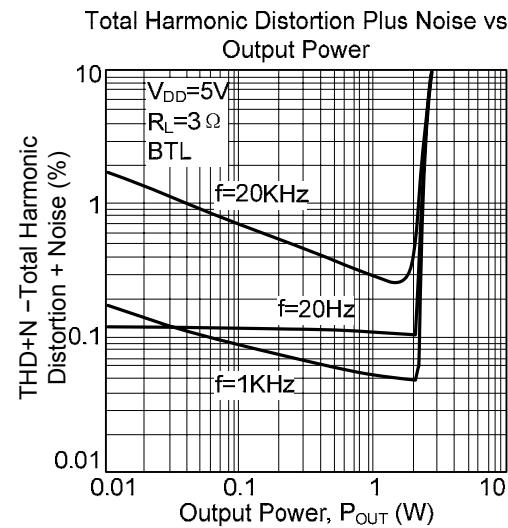
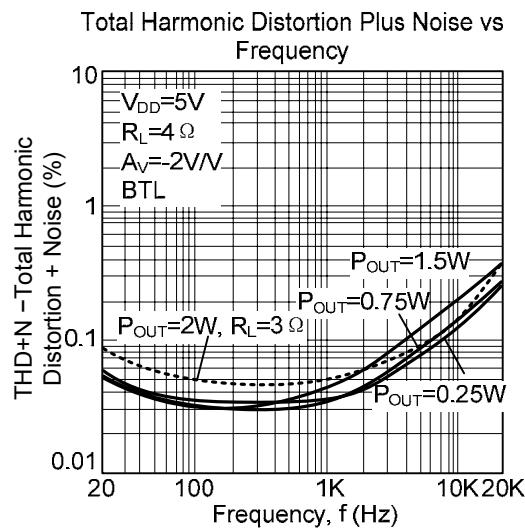


Note:1. This connection is for ultra-low current in shutdown mode.

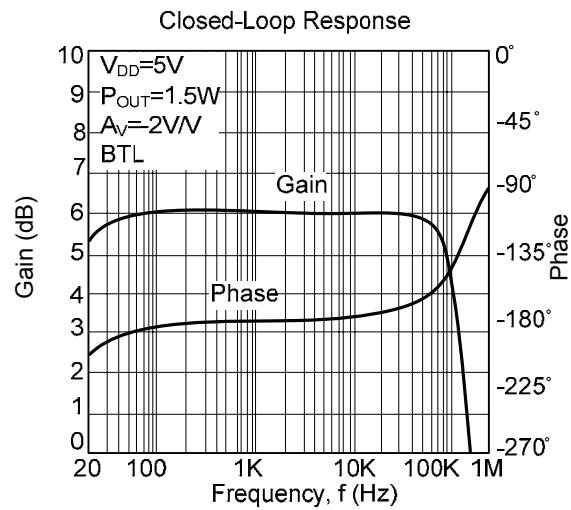
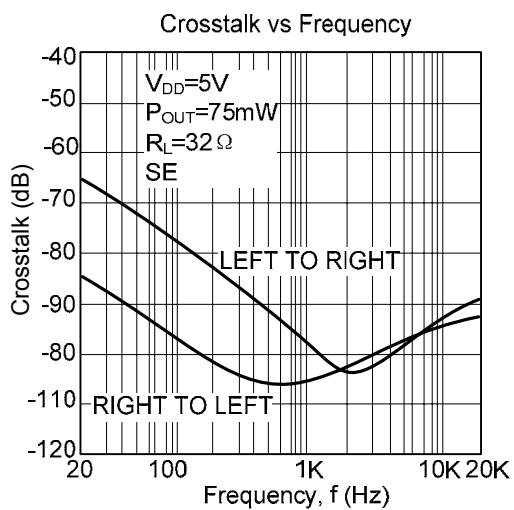
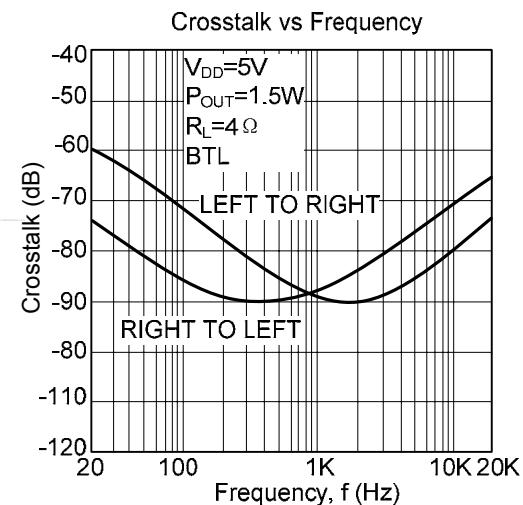
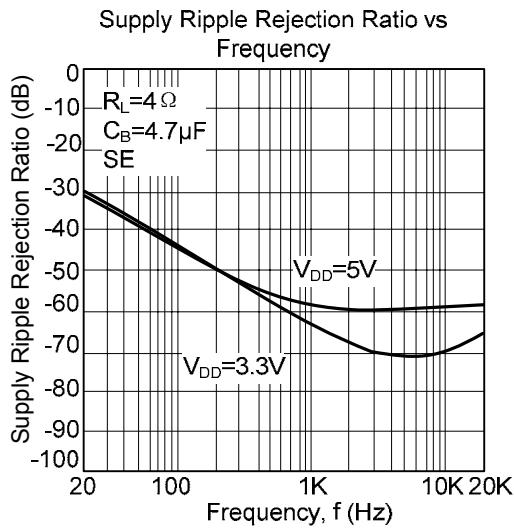
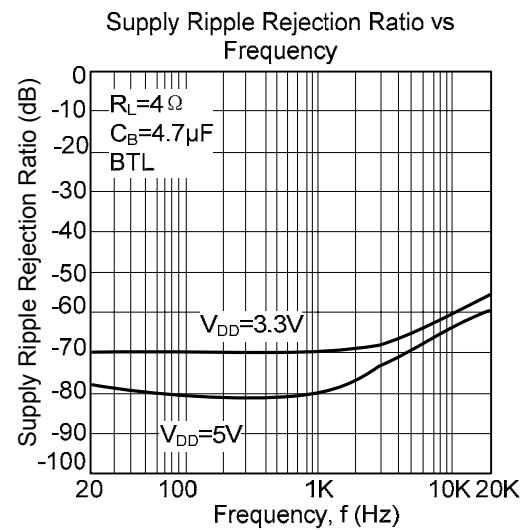
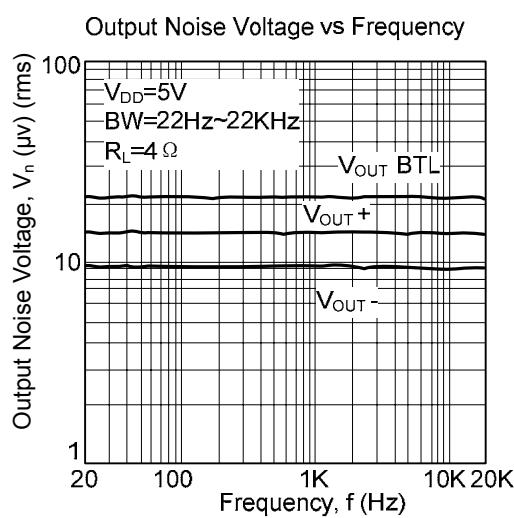
2. A 0.1  $\mu$ F ceramic capacitor should be placed as close as possible to the IC. For filtering lower-frequency noise signals, a larger aluminum electrolytic capacitor of 10  $\mu$ F or greater should be placed near the audio power amplifier.

PA3202 Full Configuration Application Circuit

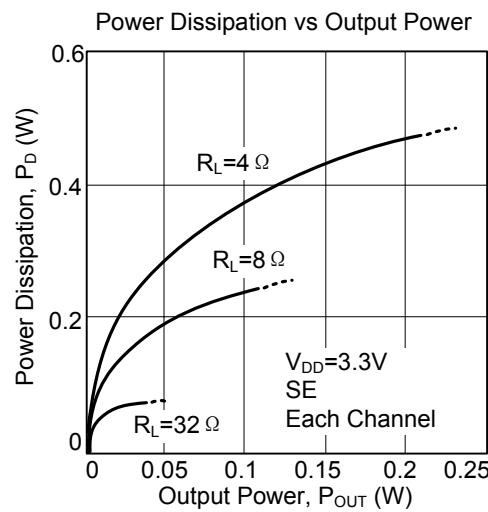
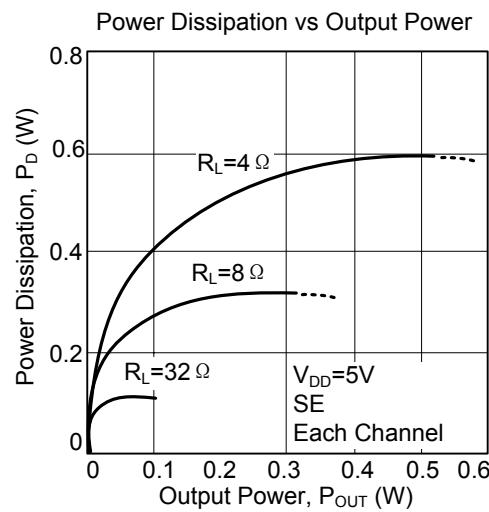
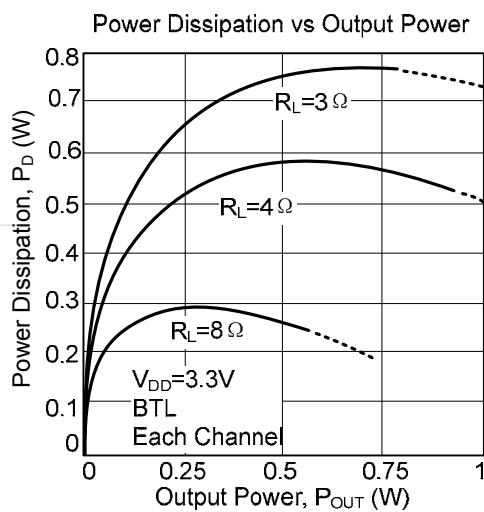
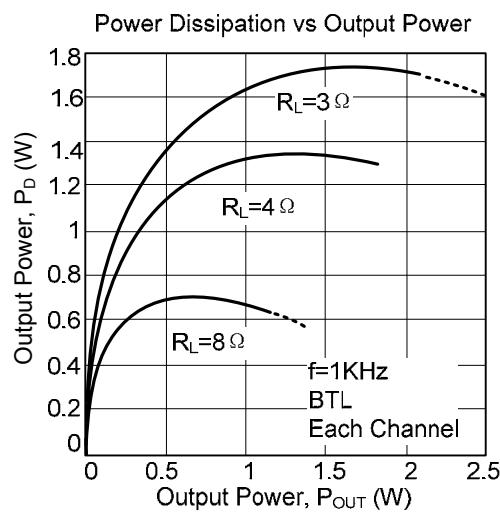
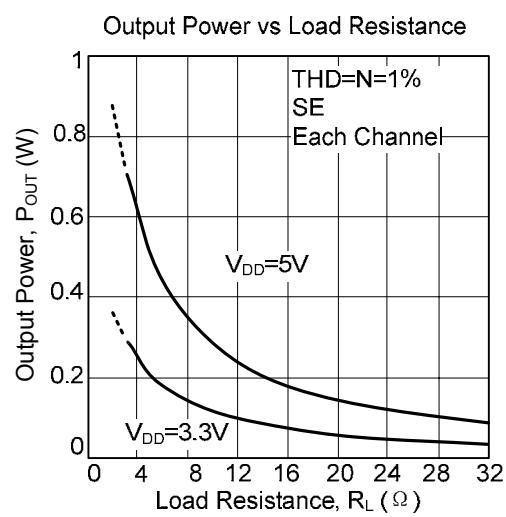
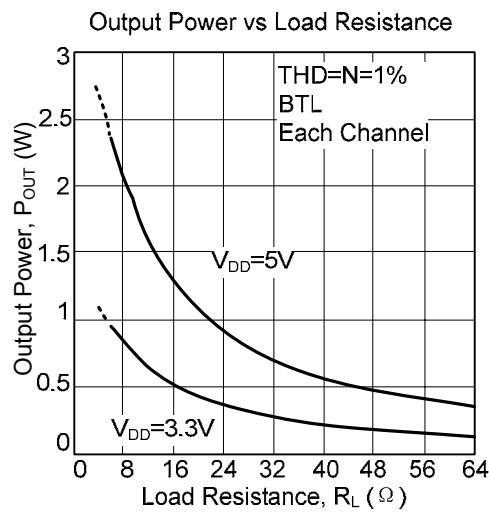
■ TYPICAL CHARACTERISTICS



## ■ TYPICAL CHARACTERISTICS(Cont.)



## ■ TYPICAL CHARACTERISTICS(Cont.)



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